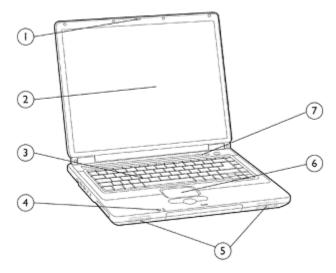
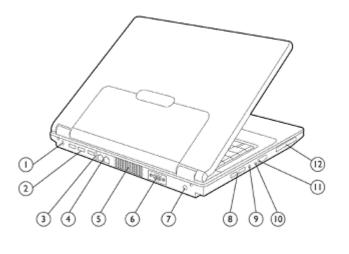
Overview

HP Neoware m100 Mobile Thin Client





- 1. Top cover latch
- 2. LCD panel
- 3. Keyboard
- 4. Status indicators power, battery
- 5. Stereo speakers
- 6. Touchpad
- 7. Quick launch buttons



Back

- 1. Cable lock slot
- 2. USB connectors (three)
- 3. RJ-45 10/100 Ethernet connector
- 4. Modem connector
- 5. Vents
- 6. VGA monitor connector
- 7. AC power connector
- 8. USB connectors (two)
- 9. Audio out (headset)
- 10. Audio in (microphone)
- 11. Wireless LAN activity indicator
- 12.PC Card slot (option)

At A Glance

- Mobile thin client
- Wireless* connectivity with built-in 802.11 b/g and PC Card slot for optional 3G broadband support
- VPN-Ready for highly secure network access
- No local storage helps prevent critical data from being lost or stolen
- No moving parts increases reliability
- Low power design extends battery life



^{*}Wireless access point and Internet service required and is not included.

Standard Features - Models

Flash

System Memory

Keyboard

Mouse

Operating System

HP P/Ns

KH150AA to KH163AA Processor KH187AA to KH190AA

Neoware P/Ns

DB-A3-xx-xxx DB-C3-xx-xxx

** Suffix varies based on Keyboard and Power Supply

-AHO (US)

-KHO (AUSTRALIAN)

-BKO (UK)

-DGO (GERMAN)

-DHO (US KB/EU PWR)

-DJO (FRENCH)

-DMO (SWEDISH)

Model HP Neoware m100

VIA Eden 800 MHz

128 MB Image - 1 GB

256 MB - 512 MB

Windows XPe

Windows XPe VDI Edition

Integrated

Integrated Touchpad



HP Neoware m100 Mobile Thin Client

QuickSpecs

Options

Accessories	Extended Life Battery	Part Number KL155AA
Memory	512 MB DDR2 RAM Upgrade 1 GB DDR2 RAM Upgrade	KE678AA KE679AA
Docking Station	Compatible with Targus Universal Docking Station	Targus ACP50US
Security	HP/Kensington Cable Lock	PC766A



Technical Specifications

Processor VIA Eden 800 MHz **Chipsets** VN800 Chipset

Memory Flash 128 MB Image - 1 GB

> **System Memory** 1256 MB - 512 MB

Graphics 15" TFT XGA panel, 1024 x 768 resolution

Mode	Refresh rates	Color depth
8-bit	85 Hz	1600x1200
16-bit	85 Hz	1600x1200
32-bit	85 Hz	1280x1024
32 bit	60 Hz	1600x1200

Input/Output/ **Peripheral Support** Keyboard Integrated – US Int'l, UK, French, German, Swedish

Mouse Integrated touchpad

Printer

Video VGA display

Audio Out / Mic In (left): Internal 2 Stereo Speakers Audio Output

Security (hardware)

Slot for Kensington Cable Lock •

ActivIdentity USB Smart Card Reader, vendor models GBURR200 & GBUR300P025

GemAlto Smart Cards (Windows XPe models only)

BioPassword (Special XPe Snap-in)

Server-based Computing **Protocols**

ICA

RDP

HP Neoware TeemTalk Terminal Emulator

Modem - 56K Data/Fax (v.92) Networking

LAN - Ethernet 10/100M, Wake on LAN, PXE

Wireless LAN – Integrated 802.11 b/g

I/O ports and connectors

5 - (2 left, 3 rear) USB Ports-2.0

Audio Jacks: Audio Out / Mic In (left)

2 – Internal Stereo Speakers 1- (rear) Modem RJ11 Port 1 - (rear) LAN RJ45 Port

1 - (rear) VGA Port-15-pin D-Sub

1 – PC Card Type II slot

System

Resident Operating Windows XPe (Also available in the VDI Edition)

Server OS

Compatibility /

Support

Citrix Presentation Server 4.0 including the Desktop Broker feature

Citrix Metaframe Presentation Server 3.0

Citrix Metaframe XP Presentation Server

Citrix Metaframe 1.x

Windows 2000/2003 Server Terminal Services

Windows 2000 Advance Server Terminal Services

Windows NT 4.0 Terminal Server Edition



Technical Specifications

- VMware Virtual Desktop Infrastructure using RDP
- Linux Terminal Server Project (LTSP) *
- Most mainframes and midrange servers **
- * Requires bios change to PXE boot
- ** Requires TeemTalk (standard on most HP Neoware thin clients)

Local software overview

Citrix ICA Java Virtual Machine

RDP RealPlayer – snap-in (add-on)
Full-function Internet Explorer Shockwave – from server
TeemTalk Emulation – 30+ Macromedia Flash
X Windows (X11R6 / XDM) – from server ELO touchscreen support

Acrobat Reader .NET Framework

Windows Media Player

Management ezRemote Manager and ezUpdate

HP Device Manager – snap-in (add-on)

Altiris – snap-in (add-on)

Security Read-only file system

Locked down user account and configuration HP Neoware Write Filter, Firewall, Security

Center

VDI Support Leostream

VDM (Propero) Provision Networks Citrix DDI support

Languages English, MUI for: French, German, Italian, Spanish, Danish, Greek

Dimensions 318 mm (W) x 277 mm (D) x 22 \sim 36.7 mm (H)

(approximate)

Weight (approximate) 5.5 lbs. (2.5 kg)

Environmental Temperature range Operating: 41° to 95° F (5° to 35° C)

Humidity 20% to 80% non-condensing

Power* Consumption: 60W

Supply: (8-cell Li-lon (4800 mAh)

* The actual power consumption at your location could vary and is dependent on many factors

including but not limited to software load on the thin client, attached peripherals, and

environmental factors.

Regulatory Compliance **Product safety** UL60950-1, CSA22.2/60950-00, IEC 60950-1:2001, AS/NZS

60950

Ergonomics

RF Interference FCC Part 15C, I.C.: RS210, EN 300 328, FCC15.247, C-Tick: EN

300 328

Warranty Hardware: 3 year limited warranty on base unit; 1 year battery

Software: 12 months

NOTE: Certain restrictions apply. Consult the HP Customer Support Center for details.

Technical Specifications

Environmentfriendly Products and Approach

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. From July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.



Technical Specifications

- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to:

http://www.hp.com/recycle or contact your nearest HP sales office.

Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

[link to new HP white paper now in progress]

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/

productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/

operations/envmanagement.html

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